

TC74HC377AP, TC74HC377AF

Octal D-Type Flip-Flop

The TC74HC377A is a high speed CMOS OCTAL D-TYPE FLIP-FLOP fabricated with silicon gate C²MOS technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

This 8-bit D-type flip-flop is controlled by a clock input (CK) and an output enable input (\overline{G}).

The signal level applied to the D inputs are transferred to Q outputs during the positive going transition of CK.

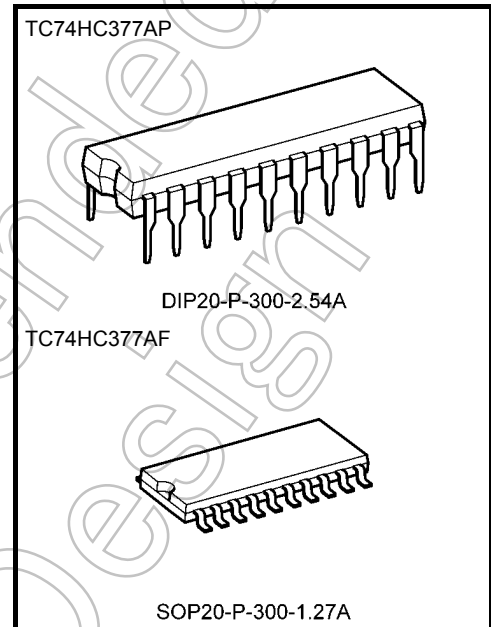
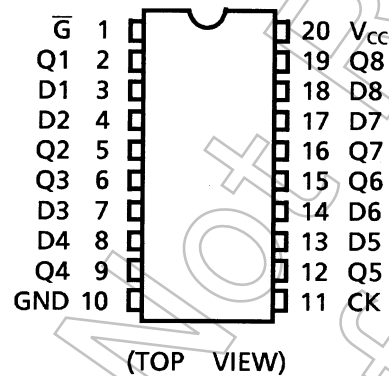
When the \overline{G} is high, the eight outputs are in a high impedance state.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

Features

- High speed: $f_{\max} = 73 \text{ MHz}$ (typ.) at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 4 \mu\text{A}$ (max) at $T_a = 25^\circ\text{C}$
- High noise immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (min)
- Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: $|I_{OH}| = I_{OL} = 4 \text{ mA}$ (min)
- Balanced propagation delays: $t_{PLH} \approx t_{PHL}$
- Wide operating voltage range: $V_{CC} (\text{opr}) = 2 \text{ to } 6 \text{ V}$
- Pin and function compatible with 74LS377

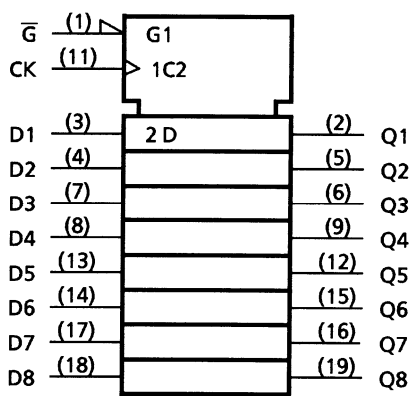
Pin Assignment






Weight	
DIP20-P-300-2.54A	: 1.30 g (typ.)
SOP20-P-300-1.27A	: 0.22 g (typ.)

Start of commercial production
1988-05

IEC Logic Symbol

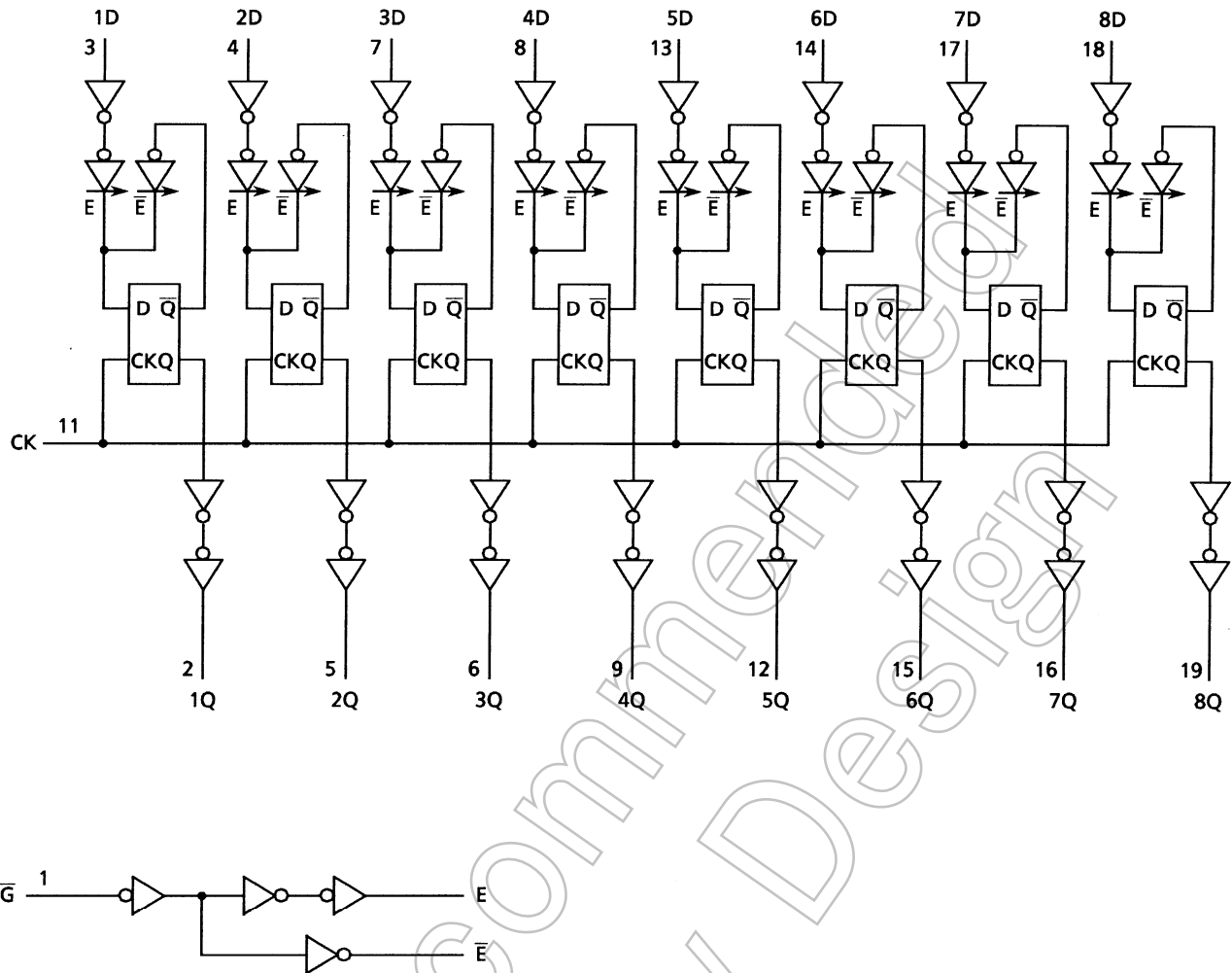


Truth Table

Inputs			Outputs
\overline{G}	CK	D	Q
H	X	X	No Change
L		L	L
L		H	H
X		X	No Change

X: Don't care

System Diagram



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V_{CC}	-0.5 to 7	V
DC input voltage	V_{IN}	-0.5 to $V_{CC} + 0.5$	V
DC output voltage	V_{OUT}	-0.5 to $V_{CC} + 0.5$	V
Input diode current	I_{IK}	± 20	mA
Output diode current	I_{OK}	± 20	mA
DC output current	I_{OUT}	± 25	mA
DC V_{CC} /ground current	I_{CC}	± 50	mA
Power dissipation	P_D	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T_{stg}	-65 to 150	$^{\circ}C$

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of $T_a = -40$ to $65^{\circ}C$. From $T_a = 65$ to $85^{\circ}C$ a derating factor of -10 mW/ $^{\circ}C$ shall be applied until 300 mW.

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V_{CC}	2 to 6	V
Input voltage	V_{IN}	0 to V_{CC}	V
Output voltage	V_{OUT}	0 to V_{CC}	V
Operating temperature	T_{opr}	-40 to 85	°C
Input rise and fall time	t_r, t_f	0 to 1000 ($V_{CC} = 2.0$ V) 0 to 500 ($V_{CC} = 4.5$ V) 0 to 400 ($V_{CC} = 6.0$ V)	ns

Note: The operating ranges must be maintained to ensure the normal operation of the device.
Unused inputs must be tied to either V_{CC} or GND.

Electrical Characteristics

DC Characteristics

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit	
				VCC (V)	Min	Typ.	Max	Min		Max
High-level input voltage	VIH	—		2.0 4.5 6.0	1.50 3.15 4.20	— — —	— — —	1.50 3.15 4.20	V	
Low-level input voltage	VIL	—		2.0 4.5 6.0	— — —	— — —	0.50 1.35 1.80	— — —	0.50 1.35 1.80	
High-level output voltage	VOH	VIN = VIH	I _{OH} = -20 μA	2.0 4.5 6.0	1.9 4.4 5.9	2.0 4.5 6.0	— — —	1.9 4.4 5.9	— — —	
			I _{OH} = -4 mA	4.5 6.0	4.18 5.68	4.31 5.80	— —	4.13 5.63	— —	
			I _{OH} = -5.2 mA	6.0	5.68	5.80	—	5.63	—	
Low-level output voltage	VOL	VIN = VIL	I _{OL} = 20 μA	2.0 4.5 6.0	— — —	0.0 0.0 0.0	0.1 0.1 0.1	— — —	0.1 0.1 0.1	
			I _{OL} = 4 mA	4.5 6.0	— —	0.17 0.18	0.26 0.26	— —	0.33 0.33	
			I _{OL} = 5.2 mA	6.0	—	0.18	0.26	—	0.33	
Input leakage current	IIN	VIN = VCC or GND		6.0	—	—	±0.1	—	±1.0	μA
Quiescent supply current	ICC	VIN = VCC or GND		6.0	—	—	4.0	—	40.0	μA

Timing Requirements (input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	Test Condition	Ta = 25°C		Ta = -40 to 85°C	Unit
			V _{CC} (V)	Typ.	Limit	
Minimum pulse width (CK)	t_W (H) t_W (L)	—	2.0	—	75	ns
			4.5	—	15	
			6.0	—	13	
Minimum set-up time (D-CK)	t_s	—	2.0	—	75	ns
			4.5	—	15	
			6.0	—	13	
Minimum set-up time (\bar{G} -CK)	t_s	—	2.0	—	75	ns
			4.5	—	15	
			6.0	—	13	
Minimum hold time	t_h	—	2.0	—	0	ns
			4.5	—	0	
			6.0	—	0	
Clock frequency	f	—	2.0	—	7	MHz
			4.5	—	36	
			6.0	—	42	

AC Characteristics ($C_L = 15 \text{ pF}$, $V_{CC} = 5 \text{ V}$, Ta = 25°C, input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Output transition time	t_{TLH}	—	—	4	8	ns
	t_{THL}					
Propagation delay time (CK-Q)	t_{pLH}	—	—	14	24	ns
	t_{pHL}					
Maximum clock frequency	f_{max}	—	38	73	—	MHz

AC Characteristics ($C_L = 50 \text{ pF}$, input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	Test Condition	$T_a = 25^\circ\text{C}$			$T_a = -40 \text{ to } 85^\circ\text{C}$		Unit
			$V_{CC} \text{ (V)}$	Min	Typ.	Max	Min	Max
Output transition time	t_{TLH} t_{THL}	—	2.0	—	30	75	—	95
			4.5	—	8	15	—	19
			6.0	—	7	13	—	16
Propagation delay time (CK-Q)	t_{pLH} t_{pHL}	—	2.0	—	57	140	—	175
			4.5	—	17	28	—	35
			6.0	—	13	24	—	30
Maximum clock frequency	f_{\max}	—	2.0	7	18	—	6	—
			4.5	36	59	—	29	—
			6.0	42	77	—	34	—
Input capacitance	C_{IN}	—	—	—	5	10	—	10
Power dissipation capacitance	C_{PD} (Note)	—	—	—	32	—	—	—

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

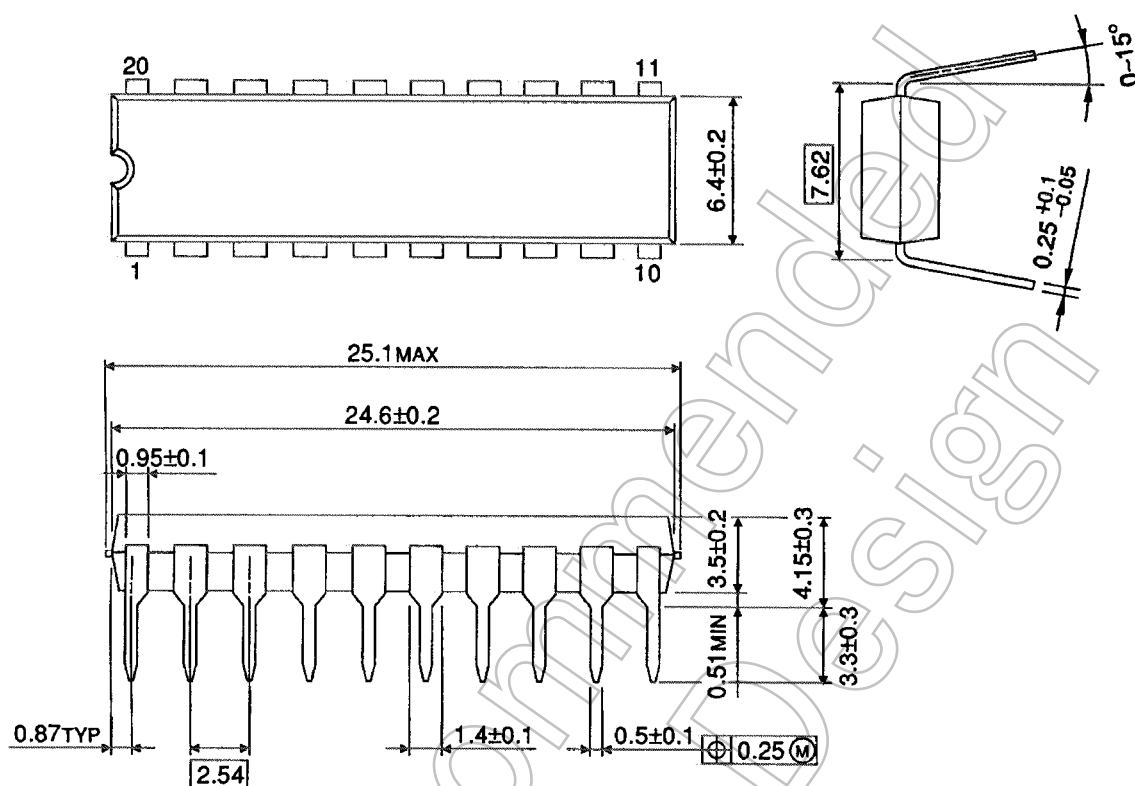
$$I_{CC}(\text{opr}) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per flip flop)}$$

And the total C_{PD} when n pcs. of flip flop operate can be gained by the following equation:

$$C_{PD}(\text{total}) = 22 + 10 \cdot n$$

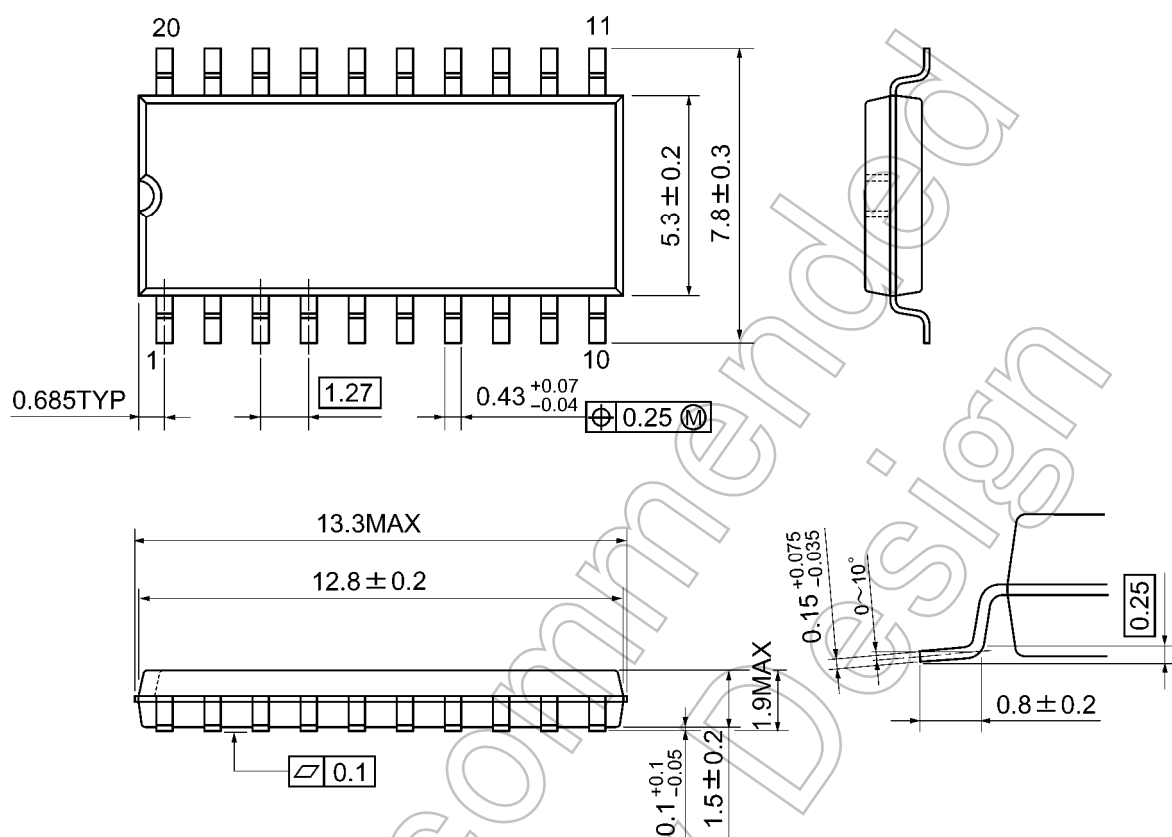
DIP20-P-300-2.54A

Unit : mm



Weight: 1.30 g (typ.)

Unit: mm



Weight: 0.22 g (typ.)

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